IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

Alexander Tetelbaum

Serial No.:

09/849,691

Filed:

04-May-2001

For:

Minimal Bends Conne

for Wire Density C

Group Art Unit:

2123

Examiner:

Hogan, Mary

Atty Docket:

00-653

I hereby certify that this correspondence is being deposited with the U.S. Postal Service as First Class Mail in an envelope addressed to: Commissioner for Patents, P. O. Box 1450, Alexandria, VA 22313-1450, on the date below:

Connie Del Castillo

Date

Signature

SUBMISSION OF FORMAL DRAWINGS PURSUANT TO 37 C.F.R. §1.85

Official Draftsman

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Sir:

Applicant hereby substitutes the enclosed formal drawings for those presently in the above referenced application.

LSI Logic Corporation 1621 Barber Lane, MS D-106 Milipitas, CA 95035 (408) 433-8000

Date: 4 MAY 06

Respectfully submitted,

Timothy Croll

Reg. No.: 36,771